13340 13340	Subclass	SSUE CLASSIFICATION
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PATENT NUMBER					

357

U.S. **UTILITY** Patent Application

O.I.P.E. PATENT DATE

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APPLICATION NO. CONT/PRIOR CLASS SUBCLASS ART UNIT EXAMINER KIEL/AV
09/893340 D 438 459 2813

PPLICANTS

TITLE

Sien Kang Igor Malik

Surface finishing of SOI substrates using an EPI process

PTO-20 12/99

ISSUING CLASSIFICATION								
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orm PTO-436A Rev. 6/99)			FILED WITH:	DISK (CRF)	FICHE CD-RO	